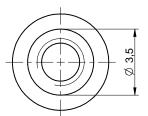
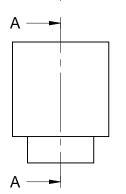
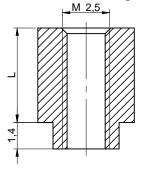
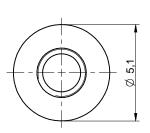
Dimensions: [mm]





sectional drawing A-A



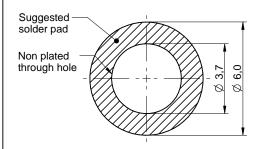




Article Properties:

Properties		Value	Unit	Tol.
Length	L	2	mm	±0.1mm

Recommended Land Pattern: [mm]



Tightening Torque Certification:

Solder Cream Thickness

Properties:

Properties

Material

Surface

RoHS Approval	Compliant [2011/65/EU&2015/863]
REACh Approval	Conform or declared [(EC)1907/2006]
Halogen Free	Conform[IEC 61249-2-21]
Halogen Free	Conform [JEDEC JS709B]

Value

150

0.35

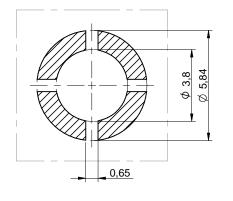
Steel

Tin

Unit | Tol.

μm | min.

Stencil Suggestion:



General Information:

CHECKED

REVISION

DATE (YYYY-MM-DD)

Operating Temperature	-55 up to +150 °C				
Storage Conditions (in original packaging)	< 40 °C; < 75 % RH				
Moisture Sensitivity Level (MSL)	1				

In Tape & Reel packaging a kapton-film is fixed on the top of the spacer for automatic assembly.

During the programming of the Pick and Place machine and the AOI, please consider the flap of the kapton-film.

During the design of the PCB layout, please consider the flap of the kapton-film. If more SMT Spacers are placed close to each other, the flap may disturb the Pick and Place process.

ROHS COMPLIANT COMPLIANT PRIZE	
	Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldemburg Germany Tel. +49 (0) 79 42 945 - 0

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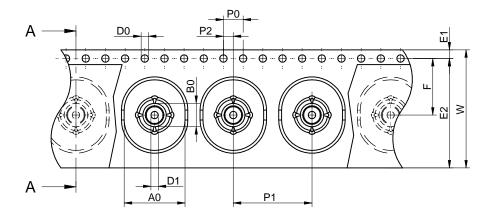
eiSos@we-online.com

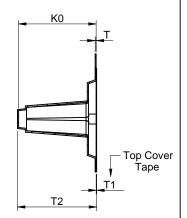
JuSa 001.001 2020-04-30 DIN ISO 2768-1m **WA-SMSI SMT Steel Spacer with** internal Thread ORDER CODE 9774020151R SIZE/TYPE BUSINESS UNIT STATUS PAGE M2.5 Valid 1/5 eiCan

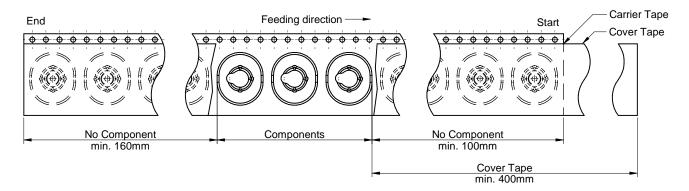
GENERAL TOLERANCE

WÜRTH ELEKTRONIK

Packaging Specification - Tape: [mm]



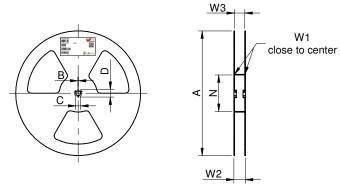


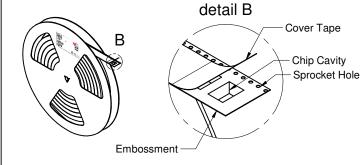


Packaging is referred to the international standard IEC 60286-3:2019

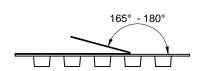
		Tape Type	A0 (mm)	B0 (mm)	W (mm)	T (mm)	T1 (mm)	T2 (mm)	K0 (mm)	PO (mm)	P1 (mm)	P2 (mm)	DO (mm)	D1 (mm)	E1 (mm)	E2 (mm)	F (mm)	Material	Qty. (pcs.)
Tol	erance		typ.	typ.	+0,3/ -0,1	ref.	ref.	typ.	typ.	±0,1	±0,1	±0,1	+0,1/-0,0	min.	±0,1	min.	±0,1		
Val	ue	2a	10,00	4,20	24,00	0,50	0,10	4,00	3,70	4,00	16,00	2,00	1,50	1,50	1,75	22,25	11,50	Polystyrene	1050

Packaging Specification - Reel: [mm]





	A (mm)	B (mm)	C (mm)	D (mm)	N (mm)	W1 (mm)	W2 (mm)	W3 (mm)	W3 (mm)	Material
Tolerance	± 2,0	min.	min.	min.	min.	+ 2,0	max.	min.	max.	
Value	330,00	1,50	12,80	20,20	60,00	24,40	30,40	23,90	27,40	Polystyrene



Pull-of force 24 mm 0,1 N - 1,3 N Tape width



Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg

Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com

WA-SMSI SMT Steel Spacer with internal Thread

DATE (YYYY-MM-DD)

2020-04-30

CHECKED

JuSa

M2.5

REVISION

001.001

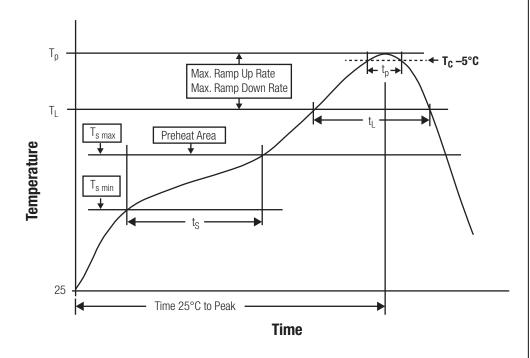
9774020151R SIZE/TYPE BUSINESS UNIT STATUS PAGE Valid 2/5 eiCan

ORDER CODE

GENERAL TOLERANCE

DIN ISO 2768-1m

Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

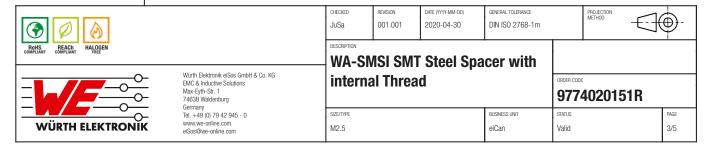
Profile Feature		Value
Preheat Temperature Min 1)	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time t _s from T _{s min} to T _{s max}	t _s	60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	T _L	217 °C
Time t _L maintained above T _L	t _L	60 - 150 seconds
Peak package body temperature	T _p	$T_p \le T_c$, see Table below
Time within 5°C of actual peak temperature	t _p	20 - 30 seconds
Ramp-down Rate (T _P to T _L)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

¹⁾ refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature (T_c):

Properties	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000
PB-Free Assembly Package Thickness < 1.6 mm ¹⁾	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly Package Thickness ≥ 2.5 mm	250 °C	245 °C	245 °C

¹⁾ refer to IPC/JEDEC J-STD-020D refer to IPC/ JEDEC J-STD-020E



Cautions and Warnings:

The following conditions apply to all goods within the product series of WA-SMSI of Würth Elektronik eiSos GmbH & Co. KG:

General:

- This mechanical component was designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any
 equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control,
 ship control), transportation signal, disaster prevention, medical, public information network, etc. where higher safety and reliability are
 especially required and/or if there is the possibility of direct damage or human injury.
- Mechanical components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions
 specified in the datasheet are not met, the component surface may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged.
- Würth Elektronik products are qualified according to international standards. Würth Elektronik does not warrant any customer qualified
 product characteristics beyond Würth Elektronik's specifications, for its validity and sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the
 authority of the customer. All technical specifications for standard products do also apply to customer specific products.

Product Specific:

Soldering:

- The solder profile must comply with the Würth Elektronik technical soldering specification. All other profiles will void the warranty.
- All other soldering methods are at the customers' own risk.

Cleaning and Washing:

- Washing agents used during the production to clean the customer application might damage or change the characteristics of the component. Washing agents may have a negative effect on the long-term functionality of the product.
- Using a brush during the cleaning process may damage the component. Therefore, we do not recommend using a brush during the PCB cleaning process.

Potting:

If the product is potted in the customer application, the potting material might shrink or expand during and after hardening. Shrinking
could lead to an incomplete seal, allowing contaminants into the components. Expansion could damage the components. We
recommend a manual inspection after potting or coating to avoid these effects.

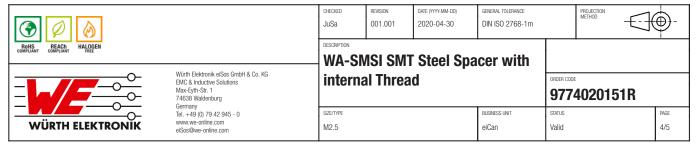
Storage Conditions:

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Therefore, all products shall be used within the
 period of 12 months based on the day of shipment.
- Do not expose the components to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

Handling:

- The maximum permissible torques must be observed to prevent mechanical destruction of the component and PCB.
- Violation of the technical product specifications will void the warranty.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.



Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

